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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Trejo, Luis
Application No: 09/961,165
Filed: 9/21/2001
Art Unit:
Examiner:
Docket No.: TI-21129
Conf. No.: 4601
Customer No.: 23494

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<input checked="" type="checkbox"/> FACSIMILE COVER SHEET (1 SHEET) <input type="checkbox"/> NEW APPLICATION <input type="checkbox"/> DECLARATION <input type="checkbox"/> ASSIGNMENT <input type="checkbox"/> FORMAL DRAWINGS <input type="checkbox"/> INFORMAL DRAWINGS <input type="checkbox"/> CONTINUATION APP'N <input type="checkbox"/> DIVISIONAL APP'N	<input type="checkbox"/> AMENDMENT _____ <input type="checkbox"/> EOT _____ <input type="checkbox"/> NOTICE OF APPEAL _____ <input type="checkbox"/> APPEAL _____ <input type="checkbox"/> ISSUE FEE _____ <input checked="" type="checkbox"/> REPLY BRIEF (IN TRIPPLICATE) <input type="checkbox"/> Comes Addrs Change
NAME OF INVENTOR(S): Trejo, Luis	RECEIPT DATE & SERIAL NO.: Serial No.: 09/961,165
TITLE OF INVENTION: Method For Controlling Wire Balls In Electronic Bonding	
TI FILE NO.: TI-21129	DEPOSIT ACCT. NO.: 20-0668
FAXED: 07/11/2008	
DUE: _____	
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